



## 16μA IQ, 1.2A PWM Step-Down DC-DC Converters

### **General Description**

The MAX1556/MAX1556A/MAX1557 are low-operatingcurrent (16µA), fixed-frequency step-down regulators. High efficiency, low-quiescent operating current, low dropout, and minimal (27µA) guiescent current in dropout make these converters ideal for powering portable devices from 1-cell Li-ion or 3-cell alkaline/NiMH batteries. The MAX1556 delivers up to 1.2A: has pinselectable 1.8V, 2.5V, and 3.3V outputs; and is also adjustable. The MAX1557 delivers up to 600mA; has pinselectable 1V, 1.3V, and 1.5V outputs; and is also adjustable.

The MAX1556/MAX1556A/MAX1557 contain a low-onresistance internal MOSFET switch and synchronous rectifier to maximize efficiency and dropout performance while minimizing external component count. A proprietary topology offers the benefits of a high fixedfrequency operation while still providing excellent efficiency at both light and full loads. A 1MHz PWM switching frequency keeps components small. Both devices also feature an adjustable soft-start to minimize battery transient loading.

The MAX1556/MAX1556A/MAX1557 are available in a tiny 10-pin TDFN (3mm x 3mm) package.

### **Applications**

PDAs and Palmtop Computers Cell Phones and Smart Phones Digital Cameras and Camcorders Portable MP3 and DVD Players Hand-Held Instruments

## **Features**

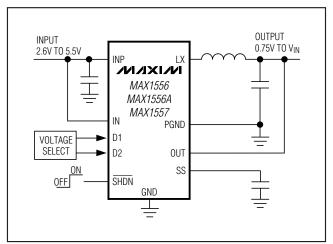
- ♦ Up to 97% Efficiency
- ♦ 95% Efficiency at 1mA Load Current
- ♦ Low 16µA Quiescent Current
- ♦ 1MHz PWM Switching
- ♦ Tiny 3.3µH Inductor
- ♦ Selectable 3.3V, 2.5V, 1.8V, 1.5V, 1.3V, 1.2V, 1.0V, and Adjustable Output
- **♦ 1.2A Guaranteed Output Current** (MAX1556/MAX1556A)
- **♦ Voltage Positioning Optimizes Load-Transient** Response
- ♦ Low 27µA Quiescent Current in Dropout
- ♦ Low 0.1µA Shutdown Current
- ♦ No External Schottky Diode Required
- ♦ Analog Soft-Start with Zero Overshoot Current
- ♦ Small, 10-Pin, 3mm x 3mm TDFN Package

### **Ordering Information**

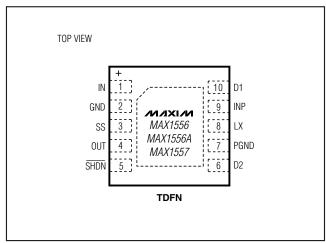
PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX1556ETB+	-40°C to +85°C	10 TDFN-EP*	ACQ
MAX1556AETB+	-40°C to +85°C	10 TDFN-EP*	AUJ
MAX1557ETB+	-40°C to +85°C	10 TDFN-EP*	ACR

<sup>\*</sup>EP = Exposed paddle.

## Typical Operating Circuit



## Pin Configuration



Maxim Integrated Products 1

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

#### **ABSOLUTE MAXIMUM RATINGS**

IN, INP, OUT, D2, SHDN to GND0.3V to +6.0V	Operating Temperature Range40°C to +85°C
SS, D1 to GND0.3V to (V <sub>IN</sub> + 0.3V)	Junction Temperature+150°C
PGND to GND0.3V to +0.3V	Storage Temperature Range65°C to +150°C
LX Current (Note 1)±2.25A	Lead Temperature (soldering, 10s)+300°C
Output Short-Circuit DurationContinuous	Soldering Temperature (reflow)+260°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C) 10-Pin TDFN (derate 24.4mW/°C above +70°C)1951mW	

**Note 1:** LX has internal clamp diodes to GND and IN. Applications that forward bias these diodes should take care not to exceed the IC's package power-dissipation limits.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = V_{INP} = V_{\overline{SHDN}} = 3.6V, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNITS	
Input Voltage			2.6		5.5	V	
Undervoltage-Lockout Threshold	V <sub>IN</sub> rising and falling, 35mV hysteresis (typ)		2.20	2.35	2.55	V	
Quiescent Supply Current	No switching, D1 = D2	e = GND		16	25	μА	
Quiescent Supply Current	Dropout			27	42		
Shutdown Supply Current	SHDN = GND	$T_A = +25^{\circ}C$		0.1	1		
Shataown Supply Current	SHDIN = GIND	$T_A = +85^{\circ}C$		0.1		μΑ	
Output Voltage Range			0.75		$V_{IN}$	V	
		No load	-0.25	+0.75	+1.75		
	T. 000 to .0500	300mA load	-0.75	0	+0.75		
	$T_A = 0^{\circ}C \text{ to } +85^{\circ}C$ (Note 2)	600mA load	-1.5	-0.75	0		
	(14010 2)	1200mA load, MAX1556	-2.75	-2.25	-1.25		
Output Accuracy		1200mA load, MAX1556A		-2.25		%	
	T <sub>A</sub> = -40°C to +85°C (Note 2)	No load	-0.75		+2.25		
		300mA load	-1.5		+1.5		
		600mA load	-2.25		+0.50		
		1200mA load, MAX1556	-4.0		-1.0		
Maximum Output Current	MAX1556/MAX1556A		1200			mA	
Maximum Output Current	MAX1557		600			IIIA	
	D1 = D2 = GND	$T_A = +25^{\circ}C$		0.01	0.1		
OUT Bias Current	MAX1556/MAX1557	T <sub>A</sub> = +85°C		0.01		μΑ	
	For preset output volta	ges		3	4.5		
	D1 = D2 = GND,	No load	-0.50	+0.75	+1.75		
	$V_{OUT} = 0.75V$ at	300mA load	-1.2	0	+1.2		
FB Threshold Accuracy	300mA (typ), T <sub>A</sub> = 0°C to +85°C	600mA load	-1.75	-0.75	+0.25		
	MAX1556/MAX1557	1200mA load, MAX1556 only	-3.25	-2.25	-1.25		
	D1 = D2 = GND,	No load	-1.25		+2.25	%	
	$V_{OUT} = 0.75V$	300mA load	-1.75		+1.50		
	at 300mA (typ),	600mA load	-2.75		+0.25		
	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ MAX1556/MAX1557	1200mA load, MAX1556 only	-4.25		-1.00		

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### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = V_{INP} = V_{\overline{SHDN}} = 3.6V, T_A = -40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

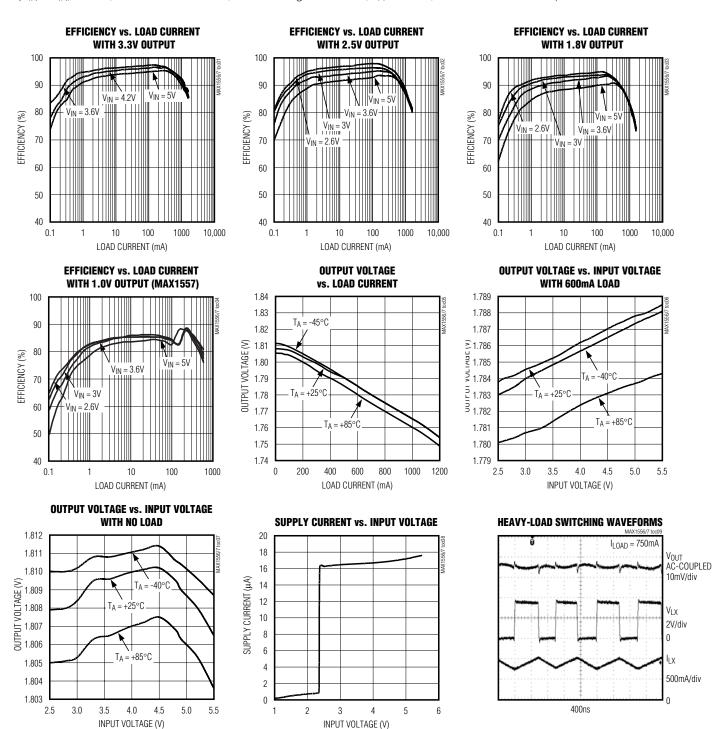
MAX1556, D1 = IN, D2 = GND; MAX1556, D1 = IN, D2 = GND; MAX1557, D1 = IN, D2 = GND; D1 = D2 = IN   MAX1557, D1 = IN, D2 = GND; D1 = IN, D2 = G	PARAMETER	(	CONDITIONS		TYP	MAX	UNITS
Line Regulation         MAX1556A D1 = D2 = IN D2 = IN D2 = IN MAX1557         VIN = 2.6V to 3.6V D1 = V.01 D1 = IN, D2 = GND D1 = IN, D2 = I			V <sub>IN</sub> = 2.6V to 3.6V		-0.37		
D1 = IN, D2 = GND   VIN = 3.6V to 5.5V   0.09   0.35   VIN = 3.6V   0.19   0.35   0.7   0.48   0.42   0.	Line Regulation	MAX1556A	V <sub>IN</sub> = 3.6V to 5.5V		0.33		%
P-Channel On-Resistance    MAX1556/MAX1556A   VIN = 3.6V   0.23   VIN = 2.6V   0.23   VIN = 2.6V   0.35   0.7   VIN = 3.6V   VIN = 3.6V   VIN = 3.6V   0.42   VIN = 2.6V   0.43   VIN = 2.6V   0.33   VIN = 2.6V   0.35   VIN = 2.6V   0.8   1.0   1.2   VIN = 3.5V, LX = GND or IN   VIN = 5.5V, LX = GND or IN   VIN = 5.5V, LX = GND or IN   VIN = 5.5V, LX = GND or IN   VIN = 4.85°C   0.1   10   VIN = 4.85°C   0.1   1.1   VIN = 3.5V, LX = GND or IN   VIN = 3.6V   VIN = 3.		MAX1557,	V <sub>IN</sub> = 2.6V to 3.6V		-0.1		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		D1 = IN, D2 = GND	V <sub>IN</sub> = 3.6V to 5.5V		0.09		1
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		MAY1EEC/MAY1EECA	$V_{IN} = 3.6V$		0.19	0.35	
MAX1557   VIN = 3.6V   0.42	n Channal On Desistance	AGCCI XAIVI/OCCI XAIVI	$V_{IN} = 2.6V$		0.23		
No   2.6V   0.42   0.27   0.48   0.48	p-Channel On-Resistance	MANACEZ	V <sub>IN</sub> = 3.6V		0.35	0.7	(2)
No		IVIAX 1007	V <sub>IN</sub> = 2.6V		0.42		
P-Channel Current-Limit Threshold   MAX1556/MAX1556A   1.5   1.8   2.1   A	n Channal On Begistance	$V_{IN} = 3.6V$			0.27	0.48	0
Threshold         MAX1557         0.8         1.0         1.2         A           n-Channel Zero Crossing Threshold         20         35         45         mA           RMS LX Output Current         MAX1556/MAX1556A MAX1557         1.8         1.8         1.0           LX Leakage Current         VIN = 5.5V, LX = GND or IN         TA = +25°C         0.1         10         μA           Maximum Duty Cycle         100         %         %         Minimum Duty Cycle         0.9         1         1.1         MHz           SS Output Impedance         ΔVSS / Iss for Iss = 2μA         130         200         300         kΩ           SS Discharge Resistance         SHDN = GND, 1mA sink current         90         200         Ω           Thermal-Shutdown Threshold         +160         °C         °C           LOGIC INPUTS (D1, D2, SHDN)         1.4         V           Input-Voltage High         2.6V ≤ VIN ≤ 5.5V         1.4         V           Input-Loglage         TA = +25°C         0.1         1         µA	n-Channel On-Resistance	$V_{IN} = 2.6V$			0.33		1 12
Threshold         MAX1557         0.8         1.0         1.2           n-Channel Zero Crossing Threshold         MAX1556/MAX1556A         20         35         45         mA           RMS LX Output Current         MAX1556/MAX1556A         1.8         ARMS           LX Leakage Current         VIN = 5.5V, LX = GND or IN         TA = +25°C         0.1         10         μA           Maximum Duty Cycle         100         %         Minimum Duty Cycle         0         %           Minimum Duty Cycle         0.9         1         1.1         MHz           SS Output Impedance         ΔVSS / ISS for ISS = 2μA         130         200         300         kΩ           SS Discharge Resistance         SHDN = GND, 1mA sink current         90         200         Ω           Thermal-Shutdown Threshold         +160         °C           Thermal-Shutdown Hysteresis         15         °C           LOGIC INPUTS (D1, D2, SHDN)         1.4         V           Input Lockage         7A = +25°C         0.1         1	p-Channel Current-Limit	MAX1556/MAX1556A		1.5	1.8	2.1	۸
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Threshold	MAX1557	MAX1557		1.0	1.2	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$						45	mA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		MAX1556/MAX1556A				1.8	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	RMS LX Output Current	MAX1557				1.0	ARMS
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		V <sub>IN</sub> = 5.5V, LX =	$T_A = +25^{\circ}C$		0.1	10	
Minimum Duty Cycle0%Internal Oscillator Frequency0.911.1MHzSS Output Impedance $\Delta V_{SS}$ / Iss for Iss = 2μA130200300kΩSS Discharge Resistance $\overline{SHDN}$ = GND, 1mA sink current90200ΩThermal-Shutdown Threshold+160°CThermal-Shutdown Hysteresis15°CLOGIC INPUTS (D1, D2, $\overline{SHDN}$ )Input-Voltage High $2.6V \le V_{IN} \le 5.5V$ 1.4VInput-Voltage Low0.4V	LX Leakage Current		T <sub>A</sub> = +85°C		0.1		μΑ
Internal Oscillator Frequency0.911.1MHzSS Output Impedance $\Delta V_{SS}$ / Iss for Iss = 2μA130200300kΩSS Discharge Resistance $\overline{SHDN}$ = GND, 1mA sink current90200ΩThermal-Shutdown Threshold+160°CThermal-Shutdown Hysteresis15°C <b>LOGIC INPUTS (D1, D2, SHDN)</b> Input-Voltage High $2.6V \le V_{IN} \le 5.5V$ 1.4VInput-Voltage Low0.4V	Maximum Duty Cycle		•	100			%
SS Output Impedance       ΔVss / Iss for Iss = 2μA       130       200       300       kΩ         SS Discharge Resistance $\overline{SHDN}$ = GND, 1mA sink current       90       200       Ω         Thermal-Shutdown Threshold       +160       °C         Thermal-Shutdown Hysteresis       15       °C <b>LOGIC INPUTS (D1, D2, SHDN)</b> Input-Voltage High $2.6V \le V_{IN} \le 5.5V$ 1.4       V         Input-Voltage Low $0.4$ V         Input Leakage $T_A = +25^{\circ}C$ 0.1       1	Minimum Duty Cycle					0	%
SS Discharge Resistance $\overline{SHDN} = \overline{GND}$ , 1mA sink current $90$ $200$ $\Omega$ Thermal-Shutdown Threshold $+160$ °C  Thermal-Shutdown Hysteresis $15$ °C <b>LOGIC INPUTS (D1, D2, <math>\overline{SHDN}</math>)</b> Input-Voltage High $2.6V \le V_{IN} \le 5.5V$ $1.4$ V  Input-Voltage Low $0.4$ V  Input Lockage $0.4$ $0.4$ V	Internal Oscillator Frequency			0.9	1	1.1	MHz
Thermal-Shutdown Threshold +160 °C Thermal-Shutdown Hysteresis 15 °C <b>LOGIC INPUTS (D1, D2, SHDN)</b> Input-Voltage High 2.6V $\leq$ V <sub>IN</sub> $\leq$ 5.5V 1.4 V  Input-Voltage Low 0.4 V  Input Lockage 1 1.4 V	SS Output Impedance	$\Delta V_{SS}$ / Iss for Iss = $2\mu$	A	130	200	300	kΩ
Thermal-Shutdown Hysteresis 15 °C LOGIC INPUTS (D1, D2, SHDN) Input-Voltage High 2.6V $\leq$ V <sub>IN</sub> $\leq$ 5.5V 1.4 V Input-Voltage Low 0.4 V T <sub>A</sub> = +25°C 0.1 1	SS Discharge Resistance	SHDN = GND, 1mA sir	nk current		90	200	Ω
LOGIC INPUTS (D1, D2, SHDN)Input-Voltage High $2.6V \le V_{IN} \le 5.5V$ $1.4$ $V$ Input-Voltage Low $0.4$ $V$ Input Legisge $T_A = +25^{\circ}C$ $0.1$ $1$	Thermal-Shutdown Threshold				+160		°C
Input-Voltage High $2.6V \le V_{\text{IN}} \le 5.5V$ 1.4 V Input-Voltage Low $0.4$ V $T_{\text{A}} = +25^{\circ}\text{C}$ 0.1 1	Thermal-Shutdown Hysteresis				15		°C
Input-Voltage Low	LOGIC INPUTS (D1, D2, SHDN)	<u> </u>		<u>.</u>			
$T_{A} = +25^{\circ}C$ 0.1 1	Input-Voltage High	$2.6V \le V_{IN} \le 5.5V$		1.4			V
	Input-Voltage Low		***			0.4	V
	Input Lookogo	T <sub>A</sub> = +25°C			0.1	1	
	input Leakage	$T_A = +85^{\circ}C$			0.1		μΑ

Note 1: All units are 100% production tested at  $T_A = +25$ °C. Limits over the operating range are guaranteed by design.

Note 2: For the MAX1556, 3.3V output accuracy is specified with a 4.2V input.

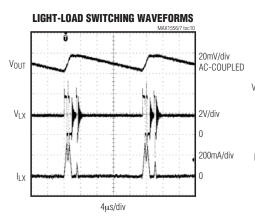
### **Typical Operating Characteristics**

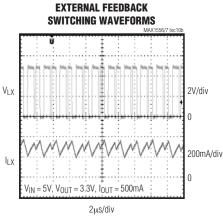
 $(V_{IN} = V_{INP} = 3.6V, D1 = D2 = \overline{SHDN} = IN, Circuits of Figures 2 and 3, T_A = +25°C, unless otherwise noted.)$ 

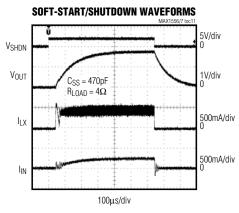


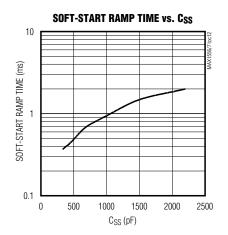
### Typical Operating Characteristics (continued)

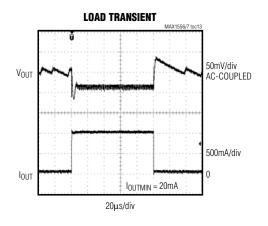
 $(V_{IN} = V_{INP} = 3.6V, D1 = D2 = \overline{SHDN} = IN, Circuits of Figures 2 and 3, T_A = +25°C, unless otherwise noted.)$ 

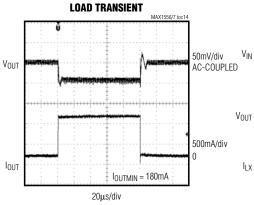


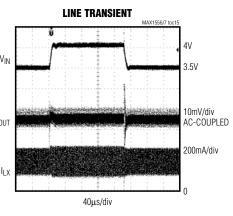


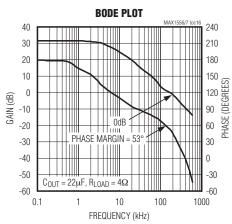












### **Pin Description**

PIN	NAME	FUNCTION		
1	IN	Supply Voltage Input. Connect to a 2.6V to 5.5V source.		
2	GND	Ground. Connect to PGND.		
3	Soft-Start Control. Connect a 1000pF capacitor (Css) from SS to GND to eliminate input-overshoot during startup. Css is required for normal operation of the MAX1556/MAX155 than 22μF total output capacitance, increase Css to Cout / 22,000 for soft-start. SS is in discharged through 200Ω to GND in shutdown.			
4	OUT	Output Sense Input. Connect to the output of the regulator. D1 and D2 select the desired output voltage through an internal feedback resistor-divider. The internal feedback resistor-divider remains connected in shutdown.		
5	Shutdown Input. Drive SHDN low to enable low-power shutdown mode. Drive high or of for normal operation.			
6	D2 OUT Voltage-Select Input. See Table 1.			
7	PGND	Power Ground. Connect to GND.		
8	LX	Inductor Connection. Connected to the drains of the internal power MOSFETs. High impedance in shutdown mode.		
		Supply Voltage, High-Current Input. Connect to a 2.6V to 5.5V source. Bypass with a 10μF ceramic capacitor to PGND.		
10	D1	OUT Voltage-Select Input. See Table 1.		
	EP	Exposed Paddle. Connect to ground plane. EP also functions as a heatsink. Solder to circuit-board ground plane to maximize thermal dissipation.		

### Table 1. Output-Voltage-Select Truth Table

	j								
D1	D2	MAX1556 Vout	MAX1556A Vout	MAX1557 V <sub>OUT</sub>					
0	0	Adjustable (VFB = 0.75) from 0.75V to VIN	3.3V	Adjustable (VFB = 0.75) from 0.75V to VIN					
0	1	3.3V	1.5V	1.5V					
1	0	2.5V	1.2V	1.3V					
1	1	1.8V	2.5V	1.0V					

A zero represents D\_ being driven low or connected to GND. A 1 represents D\_ being driven high or connected to IN.

### **Detailed Description**

The MAX1556/MAX1557 synchronous step-down converters deliver a guaranteed 1.2A/600mA at output voltages from 0.75V to V<sub>IN</sub>. They use a 1MHz PWM current-mode control scheme with internal compensation, allowing for tiny external components and a fast transient response. At light loads the MAX1556/MAX1557 automatically switch to pulse-skipping mode to keep the quiescent supply current as low as 16µA. Figures 2 and 3 show the typical application circuits.

#### **Control Scheme**

During PWM operation the converters use a fixed-frequency, current-mode control scheme. The heart of the current-mode PWM controller is an open-loop, multipleinput comparator that compares the error-amp voltage feedback signal against the sum of the amplified current-sense signal and the slope-compensation ramp. At the beginning of each clock cycle, the internal high-side p-channel MOSFET turns on until the PWM comparator trips. During this time the current in the inductor ramps up, sourcing current to the output and storing energy in the inductor's magnetic field. When the p-channel turns off, the internal low-side n-channel MOSFET turns on. Now the inductor releases the stored energy while the current ramps down, still providing current to the output. The output capacitor stores charge when the inductor current exceeds the load and discharges when the inductor current is lower than the load. Under overload conditions, when the inductor current exceeds the current limit, the high-side MOSFET is turned off and the low-side MOSFET remains on until the next clock cycle.

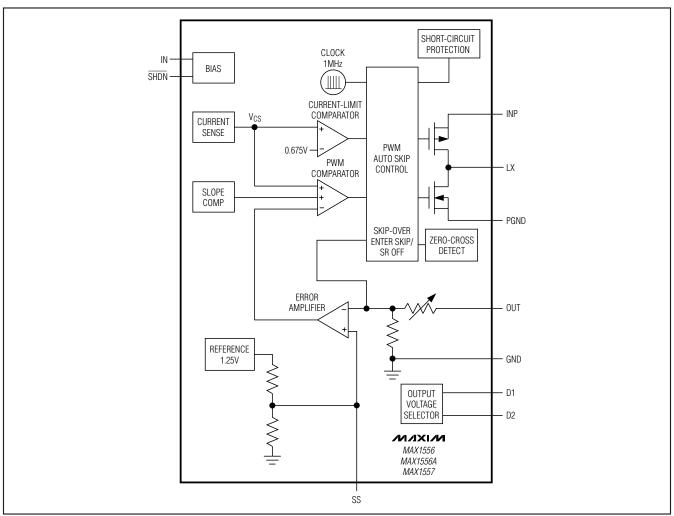


Figure 1. Functional Diagram

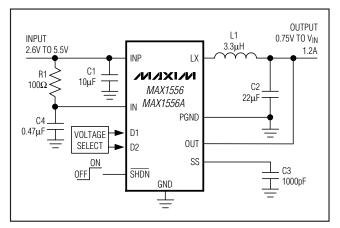


Figure 2. MAX1556 Typical Application Circuit

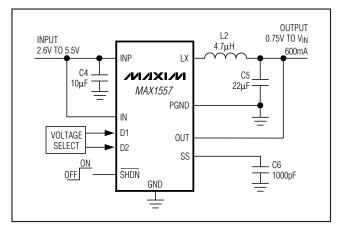


Figure 3. MAX1557 Typical Application Circuit

As the load current decreases, the converters enter a pulse-skip mode in which the PWM comparator is disabled. At light loads, efficency is enhanced by a pulse-skip mode in which switching occurs only as needed to service the load. Quiescent current in skip mode is typically 16 $\mu$ A. See the Light-Load Switching Waveforms and Load Transient graphs in the *Typical Operating Characteristics*.

#### Load-Transient Response/ Voltage Positioning

The MAX1556/MAX1556A/MAX1557 match the load regulation to the voltage droop seen during transients. This is sometimes called voltage positioning. The load line used to achieve this behavior is shown in Figures 4 and 5. There is minimal overshoot when the load is removed and minimal voltage drop during a transition from light load to full load. Additionally, the MAX1556, MAX1556A, and MAX1557 use a wide-bandwidth feedback loop to respond more quickly to a load transient than regulators using conventional integrating feedback loops (see Load Transient in the *Typical Operating Characteristics*).

The MAX1556/MAX1556A/MAX1557 use of a wide-band control loop and voltage positioning allows superior load-transient response by minimizing the amplitude and duration of overshoot and undershoot in response to load transients. Other DC-DC converters, with high gain- control loops, use external compensation to maintain tight DC load regulation but still allow large voltage droops of 5% or greater for several hundreds of microseconds during transients. For example, if the load is a CPU running at 600MHz, then a dip lasting 100µs corresponds to 60,000 CPU clock cycles.

Voltage positioning on the MAX1556/MAX1556A/ MAX1557 allows up to 2.25% (typ) of load-regulation voltage shift but has no further transient droop. Thus, during load transients, the voltage delivered to the CPU remains within spec more effectively than with other regulators that might have tighter initial DC accuracy. In summary, a 2.25% load regulation with no transient droop is much better than a converter with 0.5% load regulation and 5% or more of voltage droop during load transients. Load-transient variation can be seen only with an oscilloscope (see the *Typical Operating Characteristics*), while DC load regulation read by a voltmeter does not show how the power supply reacts to load transients.

#### **Dropout/100% Duty-Cycle Operation**

The MAX1556/MAX1556A/MAX1557 function with a low input-to-output voltage difference by operating at 100% duty cycle. In this state, the high-side p-channel

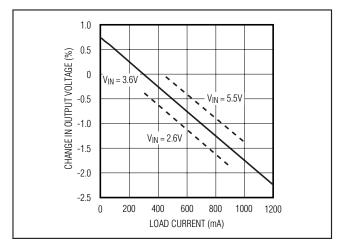


Figure 4. MAX1556 Voltage-Positioning Load Line

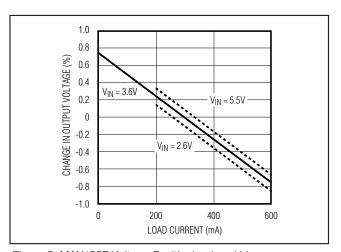


Figure 5. MAX1557 Voltage-Positioning Load Line

MOSFET is always on. This is particularly useful in battery-powered applications with a 3.3V output. The system and load might operate normally down to 3V or less. The MAX1556/MAX1556A/MAX1557 allow the output to follow the input battery voltage as it drops below the regulation voltage. The quiescent current in this state rises minimally to only  $27\mu A$  (typ), which aids in extending battery life. This dropout/100% duty-cycle operation achieves long battery life by taking full advantage of the entire battery range.

The input voltage required to maintain regulation is a function of the output voltage and the load. The difference between this minimum input voltage and the output voltage is called the dropout voltage. The dropout voltage is therefore a function of the on-resistance of the internal p-channel MOSFET (RDS(ON)P) and the inductor resistance (DCR).

**Table 2. Inductor Selection** 

MANUFACTURER	PART	VALUE (μH)	DCR (mΩ)	I <sub>SAT</sub> (mA)	SIZE (mm)	SHIELDED
Taiyo Yuden	LMNP04SB3R3N	3.3	36	1300	5 x 5 x 2.0	Yes
Taiyo Yuden	LMNP04SB4R7N	4.7	50	1200	5 x 5 x 2.0	Yes
TOKO	D52LC	3.5	73	1340	5 x 5 x 2.0	Yes
TOKO	D52LC	4.7	87	1140	5 x 5 x 2.0	Yes
Sumida	CDRH3D16	4.7	50	1200	3.8 x 3.8 x 1.8	Yes
TOKO	D412F	4.7	100*	1200*	4.8 x 4.8 x 1.2	Yes
Murata	LQH32CN	4.7	97	790	2.5 x 3.2 x 2.0	No
Sumitomo	CXL180	4.7	70*	1000*	3.0 x 3.2 x 1.7	No
Sumitomo	CXLD140	4.7	100*	800*	2.8 x 3.2 x 1.5	No

<sup>\*</sup>Estimated based upon similar-valued prototype inductors.

 $V_{DROPOUT} = I_{OUT} \times (R_{DS(ON)P} + DCR)$ 

RDS(ON)P is given in the *Electrical Characteristics*. DCR for a few recommended inductors is listed in Table 2.

#### Soft-Start

The MAX1556/MAX1556A/MAX1557 use soft-start to eliminate inrush current during startup, reducing transients at the input source. Soft-start is particularly useful for higher-impedance input sources such as Li+ and alkaline cells. Connect the required soft-start capacitor from SS to GND. For most applications using a 22µF output capacitor, connect a 1000pF capacitor from SS to GND. If a larger output capacitor is used, then use the following formula to find the value of the soft-start capacitor:

$$C_{SS} = \frac{C_{OUT}}{22000}$$

Soft-start is implemented by exponentially ramping up the output voltage from 0 to  $V_{OUT(NOM)}$  with a time constant equal to Css times  $200k\Omega$  (see the *Typical Operating Characteristics*). Assuming three time constants to full output voltage, use the following formula to calculate the soft-start time:

$$t_{SS} = 600 \times 10^3 \times C_{SS}$$

#### **Shutdown Mode**

Connecting SHDN to GND or logic low places the MAX1556/MAX1556A/MAX1557 in shutdown mode and reduces supply current to 0.1µA. In shutdown, the control circuitry and the internal p-channel and n-channel MOSFETs turn off and LX becomes high impedance. Connect SHDN to IN or logic high for normal operation.

#### Thermal Shutdown

As soon as the junction temperature of the MAX1556/MAX1556A/MAX1557 exceeds +160°C, the ICs go into thermal shutdown. In this mode the internal p-channel switch and the internal n-channel synchronous rectifier are turned off. The device resumes normal operation when the junction temperature falls below +145°C.

### Applications Information

The MAX1556/MAX1556A/MAX1557 are optimized for use with small external components. The correct selection of inductors and input and output capacitors ensures high efficiency, low output ripple, and fast transient response.

#### **Adjusting the Output Voltage**

The MAX1556/MAX1556A/MAX1557 offer preset output voltages of 1.0V, 1.2V, 1.3V, 1.5V, 1.8V, 2.5V, and 3.3V as well as an adjustable output using external resistors. Whenever possible, the preset outputs (set by D1 and D2) should be used. With external resistor feedback, noise coupling to FB can cause alternate LX pulse to terminate early resulting in an inductor current waveform with alternate large and small current pulses. See the *External Feedback Switching Waveforms* graph in *Typical Operating Characteristics* section). Note that external feedback and the alternating large-small pulse waveform do not impact loop stability and have no harmful effect on regulation or reliability.

The adjustable output is selected when D1 = D2 = 0 and an external resistor-divider is used to set the output voltage (see Figure 6). The MAX1556/MAX1557 have a defined line- and load-regulation slope. The load regulation is for both preset and adjustable outputs and is described in the *Electrical Characteristics* table and Figures 4 and 5. The impact of the line-regulation slope

can be reduced by applying a correction factor to the feedback resistor equation.

First, calculate the correction factor, k, by plugging the desired output voltage into the following formula:

$$k = 1.06 \times 10^{-2} V \times \left( \frac{V_{OUTPUT} - 0.75V}{3.6V} \right)$$

k represents the shift in the operating point at the feedback node (OUT).

Select the lower feedback resistor, R3, to be  $\leq$ 35.7k $\Omega$  to ensure stability and solve for R2:

$$\left(\frac{0.75V - k}{V_{OUTPUT}}\right) = \frac{R3}{(R3 + R2)}$$

#### **Inductor Selection**

A 4.7µH inductor with a saturation current of at least 800mA is recommended for the MAX1557 full-load (600mA) application. For the MAX1556/MAX1556A application with 1.2A full load, use a 3.3µH inductor with at least 1.34A saturation current. For lower full-load currents the inductor current rating can be reduced. For maximum efficiency, the inductor's resistance (DCR) should be as low as possible. Please note that the core material differs among different manufacturers and inductor types and has an impact on the efficiency. See Table 2 for recommended inductors and manufacturers.

#### **Capacitor Selection**

Ceramic input and output capacitors are recommended for most applications. For best stability over a wide temperature range, use capacitors with an X5R or better dielectric due to their small size, low ESR, and low temperature coefficients.

#### **Output Capacitor**

The output capacitor COUT is required to keep the output voltage ripple small and to ensure regulation loop stability. COUT must have low impedance at the switching frequency. A 22µF ceramic output capacitor is recommended for most applications. If a larger output capacitor is used, then paralleling smaller capacitors is suggested to keep the effective impedance of the capacitor low at the switching frequency.

#### Input Capacitor

Due to the pulsating nature of the input current in a buck converter, a low-ESR input capacitor at INP is required for input voltage filtering and to minimize interference with other circuits. The impedance of the input capacitor CINP should be kept very low at the switching frequency. A minimum value of 10µF is recommended at INP for

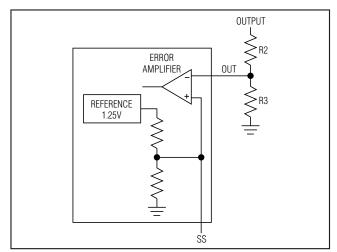


Figure 6. Adjustable Output Voltage

most applications. The input capacitor can be increased for better input filtering.

#### IN Input Filter

In all MAX1557 applications, connect INP directly to IN and bypass INP as described in the *Input Capacitor* section. No additional bypass capacitor is required at IN. For applications using the MAX1556 and MAX1556A, an RC filter between INP and IN keeps power-supply noise from entering the IC. Connect a  $100\Omega$  resistor between INP and IN, and connect a  $0.47\mu\text{F}$  capacitor from IN to GND.

#### Soft-Start Capacitor

The soft-start capacitor, Css, is required for proper operation of the MAX1556/MAX1556A/MAX1557. The recommended value of Css is discussed in the *Soft-Start* section. Soft-start times for various soft-start capacitors are shown in the *Typical Operating Characteristics*.

#### **PCB Layout and Routing**

Due to fast-switching waveforms and high-current paths, careful PCB layout is required. An evaluation kit (MAX1556EVKIT) is available to speed design.

When laying out a board, minimize trace lengths between the IC, the inductor, the input capacitor, and the output capacitor. Keep these traces short, direct, and wide. Keep noisy traces, such as the LX node trace, away from OUT. The input bypass capacitors should be placed as close as possible to the IC. Connect GND to the exposed paddle and star PGND and GND together at the output capacitor. The ground connections of the input and output capacitors should be as close together as possible.

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Chip	Info	rma	tion

PROCESS: BICMOS

### **Package Information**

For the latest package outline information and land patterns, go to <a href="www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
10 TDFN	T1033-1	21-0137	

MIXIM

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	7/04	Initial release	_
1	3/08	Adding MAX1556A as a new version	1–12
2	6/10	Added soldering temperature, added TOC for external feedback switching waveforms, and added paragraph discussing noise coupling when using external feedback resistors	1, 2, 5, 6, 9, 10, 11

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